

67,200-409; TSMC 00-661
Serial Number 09/978,420

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FROM: Tung & Associates
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DATE: 30 October 2003

REF: Applicant : Chou et al Filing Date : 15 October 2001
Serial No : 09/978,420 Att'y No. : 67,200-409
Art Unit : 2815 Examiner : N Drew Richards
Title : Microelectronic Fabrication With Upper Lying Aluminum
 Fuse Layer in Copper Interconnect Semiconductor Technology
 and Method for Fabrication Thereof

AMENDMENT FOR FILING WITH APPEAL BRIEF

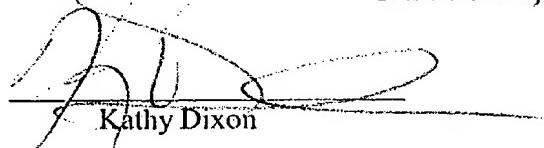
Sir:

In response to an office action mailed 30 July 2003 and made FINAL, in conjunction with the accompanying appeal brief and in accord with MPEP 1207, please consider the following amendments and remarks pertaining to the above referenced application.

There are no amendments to the specification or the drawings. Amendments to the claims are found within the Listing of the Claims that begins on page 2 of this paper. Remarks begin on page 4 of this paper.

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office at facsimile number 703-872-9319, on Dec. 30, 2003.



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Date: December 30, 2003

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Subject Matter: 09/ 978,420 Attorney Doc: 67,200-409

Message:

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